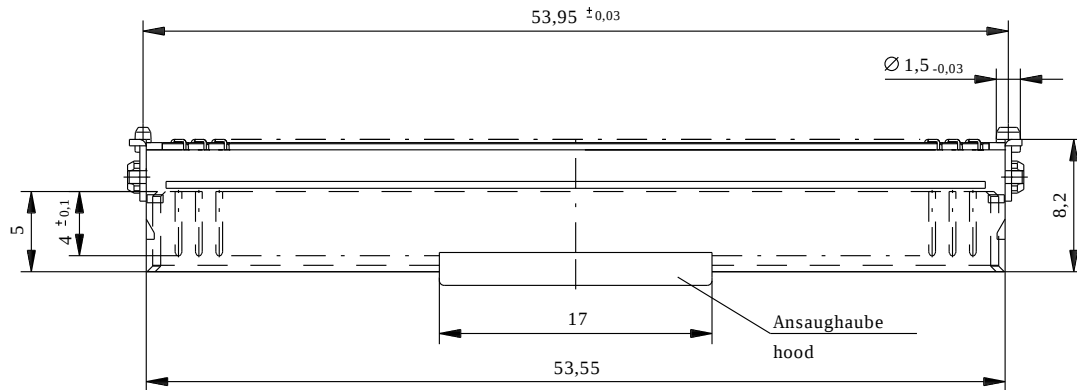
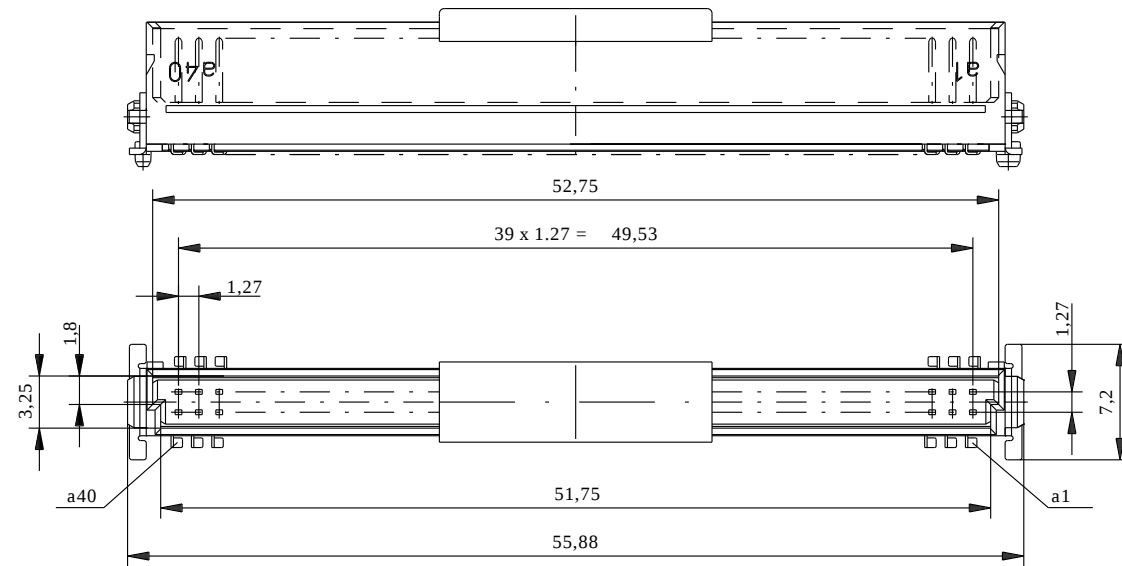
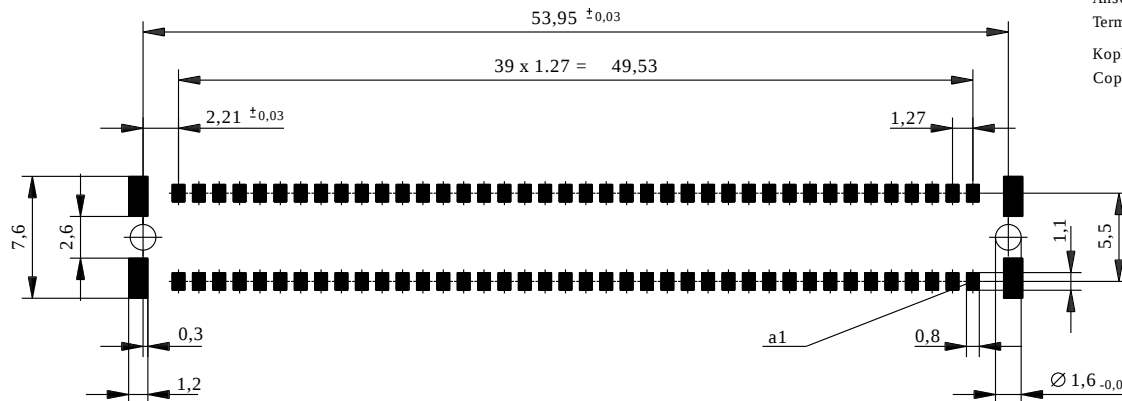




Leiterplatten-Layout Vorschlag für SMT
PCB-Layout Proposal for SMT



Anforderungsstufe 1
Performance Level 1

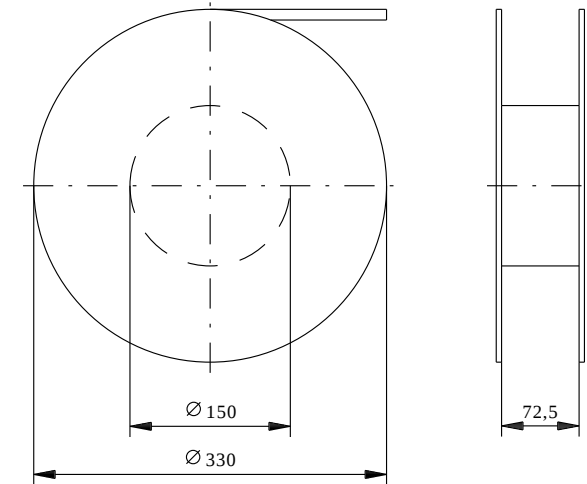
Kontaktbereich vergoldet
Mating Area gold plating

Anschlussbereich verzinkt 4-6 µm
Terminal Area 4-6 µm tin plating

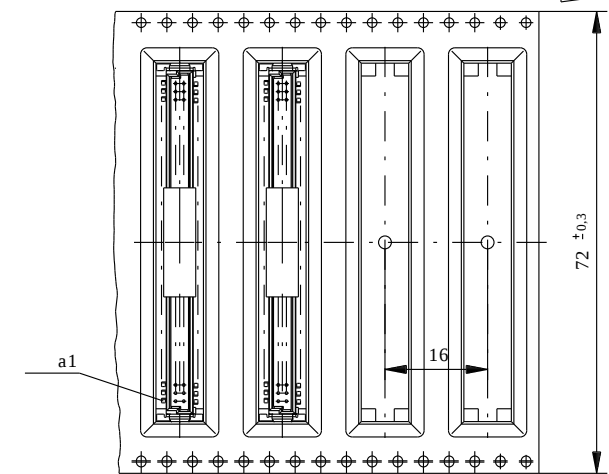
Koplanarität der Anschlüsse ≤ 0.1mm
Coplanarity Area of Termination ≤ 0.1 mm

Verpackt in Gurtverpackung
Packungseinheit: 280 Stück

- Tape on Reel Packaging
- Packaging unit: 280 pcs



Abspulrichtung - Reel off Direction



BA7-03 - Standard Bauhöhe

type7-03 - Standard Assembly Height

Consider protection memo from DIN 34

Information:				Tolerances		 All Dimensions in mm		Scale		3:1	
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								Designation			
								Messerl. SMC-Q 80-SMD-BA7-03 Male SMC-Q 80-SMD-type7-03			
a		23.08.2004		www.ERNI.com		154788		I			
Index		Date		H-00042597.SZN		SMCO					

Consider protection memo from DIN 34